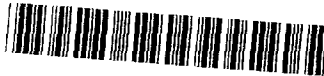


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PATENTS 2005.

B/O FORM PTO-1595 (Rev. 4/00)

Department of Commerce Patent and Trademark Office

113262 U.S. PTO  
11188848

072205

To the Commissioner for Patents. Please record the attached original documents or copies thereof.

## 1. Name of Conveying Party(ies):

Shou-Lung CHEN  
Chin-Wen HSIAO  
Yu-Hua CHEN  
Jeng-Dar KO  
Chih-Ming TZENG  
Jyh-Rong LIN  
Shan-Pu YU

## 2. Name and Address of Receiving Party(ies):

Name: Industrial Technology Research Institute

Street Address: No. 195, Sec. 4, Chung Hsing Rd.,  
Chutung

## 3. Nature of Conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other:

City, State, Zip: Hsinchu, Taiwan, R.O.C.

Execution Date: 07/19/05; 07/19/05; 07/19/05;  
07/19/05; 07/21/05; 07/19/05;  
07/19/05

☐ Additional name(s) and address(es) attached.

## 4. (A) Patent Application Number(s):

07/25/2005 STEUMEL1 00000050 11186840

05 FC:8021

40.00 DP

## 4. (B) Patent Number(s):

07/19/05;  
07/19/05;  
07/19/05;  
07/19/05;  
07/21/05;  
07/19/05;  
07/19/05

If this document is being filed together with a new  
application, the execution date of the application is:

☐ Additional Numbers Attached.

Title: Wafer-Leveled Chip Packaging Structure And Method Thereof

Attorney Docket No.: CHEN3853/EM

## 5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:

Name: Eugene Mar

23364  
CUSTOMER NUMBER

Bacon & Thomas, PLLC  
625 Slaters Lane Fourth Floor  
Alexandria, VA 22314

## Total Number of Applications and Patents Involved:

1

7. Total Fee:  
(37 CFR 3.41)

\$40.00

- ☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit Account Number: 02-0200

## 9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Eugene Mar

July 22, 2005

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and document: 5

PATENT  
REEL: 016808 FRAME: 0467

**ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: Wafer-Leveled Chip Packaging Structure and Method Thereof

the specification of which (check one):

<input checked="" type="checkbox"/>	is executed on even date herewith.	
<input type="checkbox"/>	was filed on (day-month-year)	as U.S. Application Number
<input type="checkbox"/>	was filed on (day-month-year)	as PCT Application Number
<input type="checkbox"/>	was executed on the following date(s) (day-month-year)	

WHEREAS, Industrial Technology Research Institute

having a postal address of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu, Taiwan R. O. C.

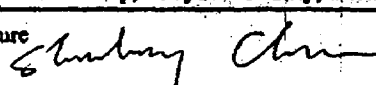
(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Bacon & Thomas, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Full Name of First or Sole Inventor <b>Shon-Lung CHEN</b>	Post Office Address <b>11F., No.102, Jhengxing Rd.,</b>
Citizenship <b>Taiwan R. O. C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Yangmei Township, Taoyuan County, Taiwan R. O. C.</b>
Date <b>2005.7.19</b>	Signature 

☒ See following page(s) for additional joint inventors.

(06Nov2001)

**SUPPLEMENTAL PAGE FOR AN  
ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

Full Name of Joint Inventor <b>Ching-Wen HSIAO</b>	Post Office Address <b>4F., No.12-3, Alley 14, Zhongxiao Rd.,</b>
Citizenship <b>Taiwan R. O. C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Banciao City, Taipei County, Taiwan R. O. C.</b>
Date <b>2005.7.19</b>	Signature <i>Ching-Wen Hsiao</i>

Full Name of Joint Inventor <b>Yu-Hua CHEN</b>	Post Office Address <b>No.36, Lane 46, Yuanji Rd., Lin 14, Zhuoshui Tsun,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Mingjian Shiang, Nantou County, Taiwan R.O.C.</b>
Date <b>2005.07.19.</b>	Signature <i>Yu-Hua Chen</i>

Full Name of Joint Inventor <b>Jeng-Dar KO</b>	Post Office Address <b>No.106, Fuqiao St., Lin 18, Tacheng Li,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Pade City, Taoyuan County, Taiwan R.O.C.</b>
Date <b>2005.07.19</b>	Signature <i>Jeng-Dar Ko</i>

Full Name of Joint Inventor <b>Chih-Ming TSENG</b>	Post Office Address <b>No.68, Wenchang St.,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Fengshan City, Kaohsiung County, Taiwan R.O.C.</b>
Date	Signature



See following page(s) for additional joint inventors.

(05Nov2001)

**SUPPLEMENTAL PAGE FOR AN  
ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

Full Name of Joint Inventor <b>Ching-Wen HSIAO</b>	Post Office Address <b>4F., No.12-3, Alley 14, Jhongsiao Rd.,</b>
Citizenship <b>Taiwan R. O. C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Banciao City, Taipei County, Taiwan R. O. C.</b>
Date	Signature

Full Name of Joint Inventor <b>Yu-Hua CHEN</b>	Post Office Address <b>No.36, Lane 46, Yuanji Rd., Lin 14, Zhuoshui Tsun,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Mingjian Shiang, Nantou County, Taiwan R.O.C.</b>
Date	Signature

Full Name of Joint Inventor <b>Jeng-Dar KO</b>	Post Office Address <b>No.106, Fuqiao St., Lin 18, Tacheng Li,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Pade City, Taoyuan County, Taiwan R.O.C.</b>
Date	Signature

Full Name of Joint Inventor <b>Chih-Ming TZENG</b>	Post Office Address <b>No.68, Wenchang St.,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Fengshan City, Kaohsiung County, Taiwan R.O.C.</b>
Date <b>2005.7.21</b>	Signature <b>Chih-Ming TZENG</b>

☒ See following page(s) for additional joint inventors.

(05Nov2001)

**SUPPLEMENTAL PAGE FOR AN  
ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

Full Name of Joint Inventor <b>Jyh-Rong LIN</b>	Post Office Address <b>No.13, Lane 21, Yanhe Rd.,</b>
Citizenship <b>Taiwan R. O. C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Tucheng City, Taipei County, Taiwan R. O. C.</b>
Date <b>2005.7.4</b>	Signature <b>Jyh-Rong Lin</b>

Full Name of Joint Inventor <b>Shan-Pu YU</b>	Post Office Address <b>No.30, Lane 432, Wunhua Rd.,</b>
Citizenship <b>Taiwan R.O.C.</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Chiayi City, Chiayi County, Taiwan R.O.C.</b>
Date <b>2005.07.19.</b>	Signature <b>Shan-Pu Yu</b>

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature



See following page(s) for additional joint inventors.

(05Nov2001)

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